

H HUDO HMFLSWR

The GreenMOS® high voltage MOSFET utilizes charge balance technology to achieve outstanding low on-resistance and lower gate charge. It is engineered to minimize conduction loss, provide superior switching performance and robust avalanche capability.

The GreenMOS® Generic series is optimized for extreme switching performance to minimize switching loss. It is tailored for high power density applications to meet the highest efficiency standards.

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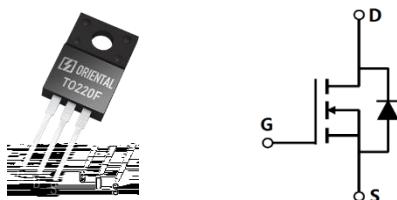
. H 3HURUP D FH 3DUDP HMUW

Parameter	Value	Unit
$V_{DS, \min} @ T_{j(\max)}$	700	V
I_D, pulse	33	A
$R_{DS(ON)}, \text{max} @ V_{GS}=10V$	380	
Q_g	12.5	nC

0 DUNL , IRUP DMR

Product Name	Package	Marking
OSG65R380FF	TO220F	OSG65R380F

3DFND H 3L , IRUP DMR



Absolute Maximum Ratings at $T_j=25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Value	Unit

Dynamic Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
Input capacitance	C _{iss}		743.4		pF	V _{GS} =0 V, V _{DS} =50 V, 00 kHz
Output capacitance	C _{oss}		63.3		pF	
Reverse transfer capacitance	C _{rss}		6.0		pF	
Turn-on delay time	t _{d(on)}		20.3		ns	V _{GS} =10 V, V _{DS} =400 V, R _G I _D =6 A
Rise time	t _r		5.4		ns	
Turn-off delay time	t _{d(off)}		29.5		ns	
Fall time	t _f		4.4		ns	

Gate Charge Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
Total gate charge	Q _g		12.5		nC	V _{GS} =10 V, V _{DS} =520 V, I _D =15 A
Gate-source charge	Q _{gs}		3.2		nC	
Gate-drain charge	Q _{gd}		4.8		nC	
Gate plateau voltage	V _{plateau}		5.7		V	

Body Diode Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
Diode forward voltage	V _{SD}			1.3	V	I _S =11 A, V _{GS} =0 V
Reverse recovery time	t _{rr}		228.6		ns	
Reverse recovery charge	Q _{rr}		2.3		C	
Peak reverse recovery current	I _{rrm}		20.4		A	

Note

- 1) Calculated continuous current based on maximum allowable junction temperature.
- 2) Repetitive rating; pulse width limited by max. junction temperature.
- 3) Pd is based on max. junction temperature, using junction-case thermal resistance.
- 4) The value of R_d is measured with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with T_a=25 °C.
- 5) V_{DD}=100 V, V_{GS}=10 V, L=80 mH, starting T_j=25 °C.

Electrical Characteristics Diagrams

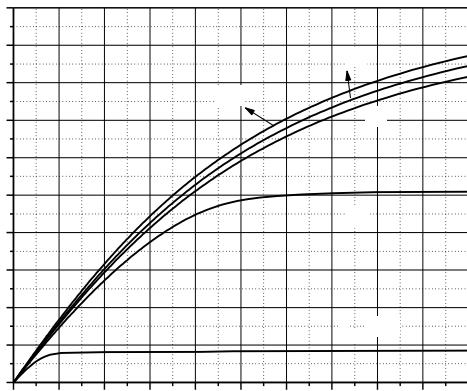


Figure 1. Typ. output characteristics

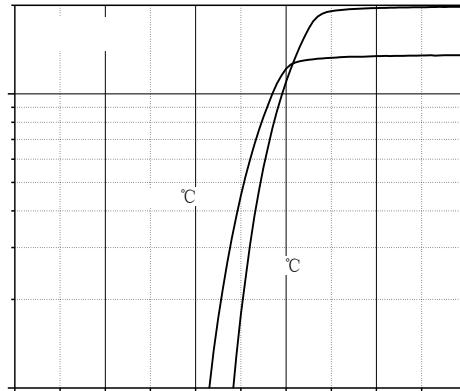


Figure 2. Typ. transfer characteristics

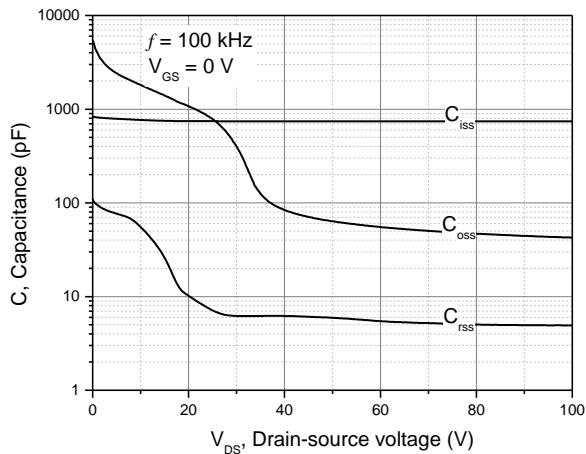


Figure 3. Typ. capacitances

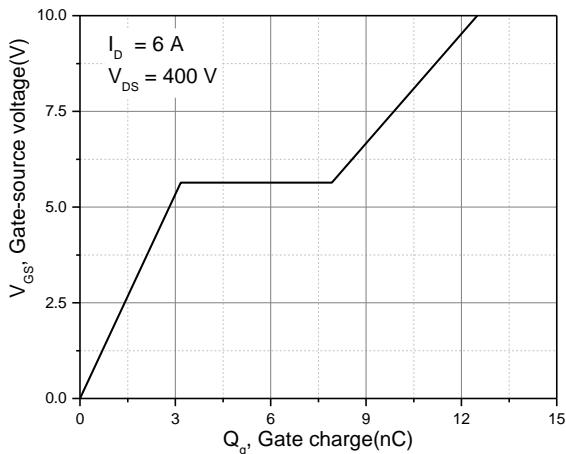


Figure 4. Typ. gate charge

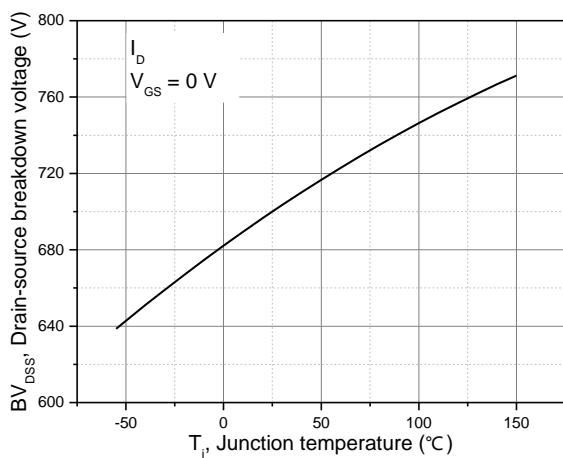


Figure 5. Drain-source breakdown voltage

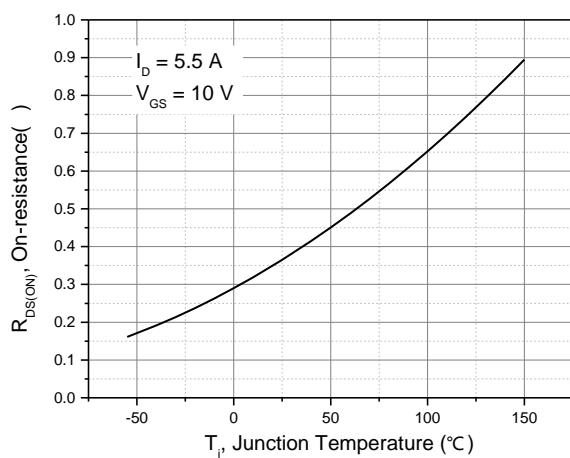


Figure 6. Drain-source on-state resistance

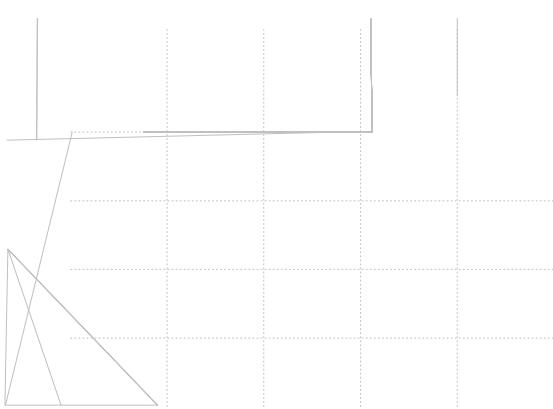


Figure 7. Threshold voltage

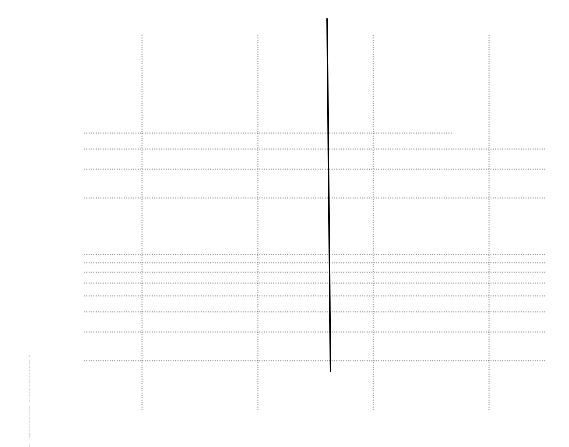


Figure 8. Forward characteristic of body diode

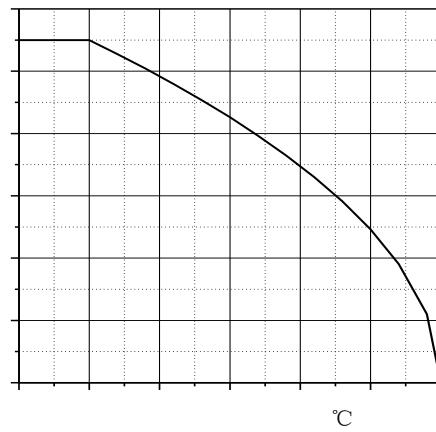


Figure 9. Drain-source on-state resistance

Figure 10. Drain current

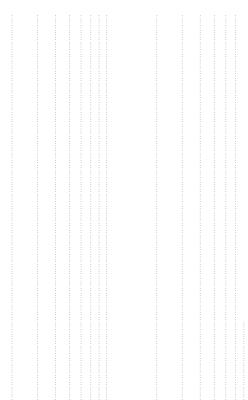
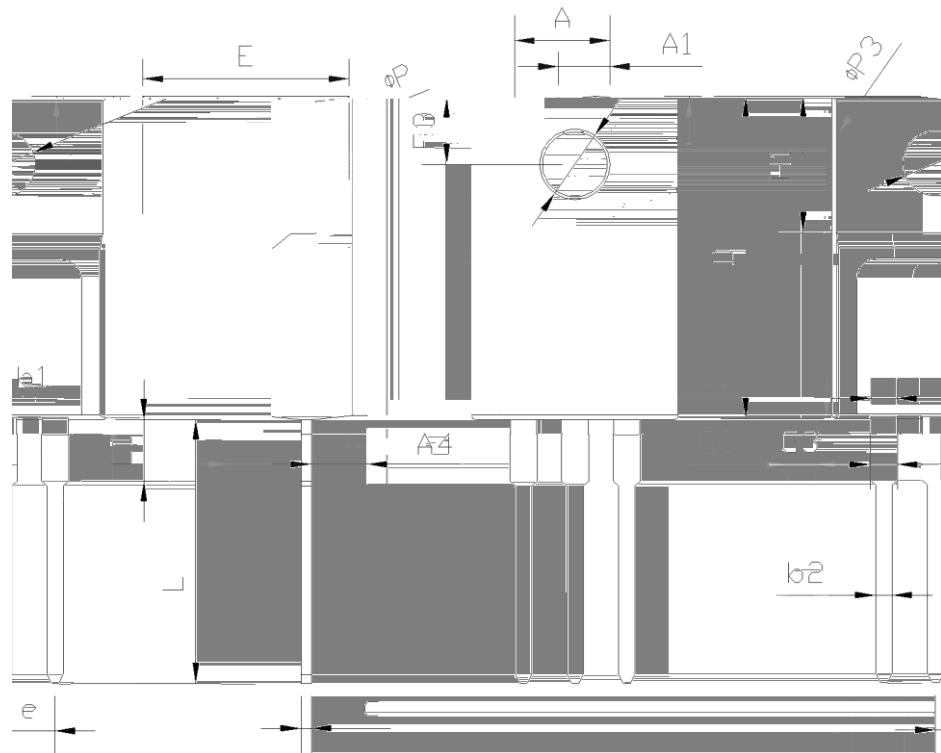


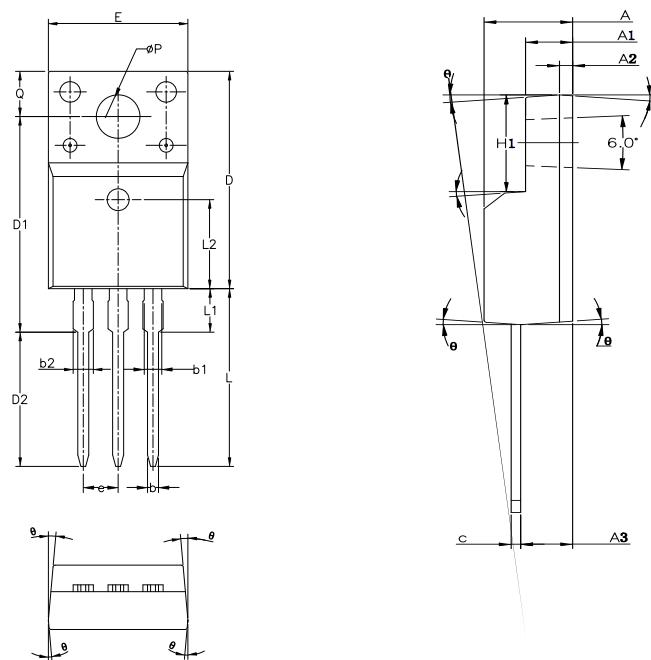
Figure 11. Safe operation area $T_c=25$

Package Information



Symbol	mm		
	Min	Nom	Max
E	9.96	10.16	10.36
A	4.50	4.70	4.90
A1	2.34	2.54	2.74
A4	2.56	2.76	2.96
c	0.40	0.50	0.65
D	15.57	15.87	16.17
H1	6.70 REF		
e	2.54 BSC		
L	12.68	12.98	13.28
L1	2.88	3.03	3.18
	3.03	3.18	3.38
	3.15	3.45	3.65
F3	3.15	3.30	3.45
G3	1.25	1.35	1.55
b1	1.18	1.28	1.43
b2	0.70	0.80	0.95

Version1: TO220F-C package outline dimension



Symbol	mm		
	Min	Nom	Max
A	4.50	4.70	4.83
A1	2.34	2.54	2.74
A2	0.70 REF		
A3	2.56	2.76	2.93
b	0.70	-	0.90
b1	1.18	-	1.38
b2	-	-	1.47
c	0.45	0.50	0.60
D	15.67	15.87	16.07
D1	15.55	15.75	15.95
D2	9.60	9.80	10.00
E	9.96	10.16	10.36
e	2.54 BSC		
H1	6.48	6.68	6.88
L	12.68	12.98	13.28
L1	-	-	3.50
L2	6.50 REF		
	3.08	3.18	3.28
Q	3.20	-	3.40
	1°	3°	5°

Version2: TO220F-J package outline dimension

Ordering Information

Package Type	Units/Tube	Tubes/Inner Box	Units/Inner Box	Inner Boxes/Carton Box	Units/Carton Box
TO220F-C	50	20	1000	6	6000
TO220F-J	50	20	1000	5	5000

Product Information

Product	Package	Pb Free	RoHS	Halogen Free
OSG65R380FF				